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Kind regards,

Team Nexperia



# PMBD7000 Double high-speed switching diode Rev. 4 — 16 September 2010

**Product data sheet** 

### 1. Product profile

#### 1.1 General description

The PMBD7000 consists of two high-speed switching diodes connected in series, fabricated in planar technology, and encapsulated in a small SOT23 (TO-236AB) Surface-Mounted Device (SMD) plastic package.

Reverse voltage:  $V_R \le 100 \text{ V}$ 

 $V_{RRM} \le 100 \text{ V}$ 

AEC-Q101 qualified

Repetitive peak reverse voltage:

#### 1.2 Features and benefits

- High switching speed:  $t_{rr} \le 4$  ns
- Repetitive peak forward current:  $I_{FRM} \le 450 \text{ mA}$
- Small SMD plastic package

#### 1.3 Applications

- High-speed switching
- General-purpose switching

#### 1.4 Quick reference data

#### Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Per diode						
I <sub>R</sub>	reverse current	V <sub>R</sub> = 100 V	-	-	0.5	μA
V <sub>R</sub>	reverse voltage		-	-	100	V
t <sub>rr</sub>	reverse recovery time		<u>[1]</u> -	-	4	ns

[1] When switched from I<sub>F</sub> = 10 mA to I<sub>R</sub> = 10 mA; R<sub>L</sub> = 100  $\Omega$ ; measured at I<sub>R</sub> = 1 mA.



Double high-speed switching diode

#### **Pinning information** 2.

Table 2.	Pinning		
Pin	Description	Simplified outline	Graphic symbol
1	anode (diode 1)		_
2	cathode (diode 2)		3
3	cathode (diode 1), anode (diode 2)	1 2	

*006aaa763* 

#### 3. **Ordering information**

Table 3. Orde	rdering information				
Type number	Package				
	Name	Description	Version		
PMBD7000	-	plastic surface-mounted package; 3 leads	SOT23		

#### Marking 4.

Type number	Marking code <sup>[1]</sup>	
PMBD7000	*5C	

\* = p: made in Hong Kong

- \* = t: made in Malaysia
- \* = W: made in China

PMBD7000 **Product data sheet** 

#### Double high-speed switching diode

### 5. Limiting values

<b>Table 5.</b> In accordar	Limiting values ace with the Absolute Maxim	um Rating System (	IEC 60134).		
Symbol	Parameter	Conditions	Min	Max	Unit
Per diode					
V <sub>RRM</sub>	repetitive peak reverse voltage		-	100	V
V <sub>R</sub>	reverse voltage		-	100	V
I <sub>F</sub>	forward current		<u>[1]</u> -	215	mA
			[2] _	125	mA
I <sub>FRM</sub>	repetitive peak forward current		-	450	mA
I <sub>FSM</sub>	non-repetitive peak forward current	square wave	[3]		
		t <sub>p</sub> = 1 μs	-	4	А
		t <sub>p</sub> = 1 ms	-	1	А
		t <sub>p</sub> = 1 s	-	0.5	А
P <sub>tot</sub>	total power dissipation	$T_{amb} \le 25 \ ^{\circ}C$	<u>[1][4]</u>	250	mW
Per device	)				
Tj	junction temperature		-	150	°C
T <sub>amb</sub>	ambient temperature		-55	+150	°C
T <sub>stg</sub>	storage temperature		-65	+150	°C

[1] Single diode loaded.

[2] Double diode loaded.

[3]  $T_j = 25 \ ^\circ C$  prior to surge.

[4] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.

## 6. Thermal characteristics

Table 6.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R <sub>th(j-a)</sub>	thermal resistance from junction to ambient	in free air	<u>[1][2]</u> _	-	500	K/W
R <sub>th(j-t)</sub>	thermal resistance from junction to tie-point		-	-	360	K/W

[1] Single diode loaded.

[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

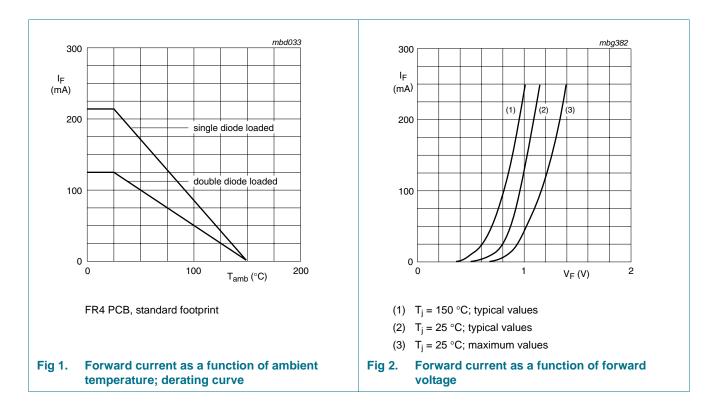
#### Double high-speed switching diode

### 7. Characteristics

Table 7. **Characteristics**  $T_i = 25 \ ^{\circ}C$  unless otherwise specified. Symbol Parameter Conditions Min Тур Max Unit Per diode  $V_{\mathsf{F}}$ forward voltage  $I_F = 1 \text{ mA}$ 550 700 m٧ - $I_F = 10 \text{ mA}$ -670 820 mV  $I_F = 50 \text{ mA}$ --1 V  $I_{F} = 100 \text{ mA}$ 0.75 1.1 V - $I_{\rm F} = 150 \, {\rm mA}$ --1.25 V  $V_{R} = 50 V$  $I_R$ reverse current --300 nA V<sub>R</sub> = 100 V --500 nΑ V<sub>R</sub> = 50 V; T<sub>i</sub> = 150 °C μΑ --100  $f = 1 MHz; V_R = 0 V$  $C_{d}$ diode capacitance --1.5 pF [1] \_ 4 t<sub>rr</sub> reverse recovery time ns [2] \_  $V_{FR}$ forward recovery voltage -1.75 V

[1] When switched from  $I_F$  = 10 mA to  $I_R$  = 10 mA;  $R_L$  = 100  $\Omega$ ; measured at  $I_R$  = 1 mA.

[2] When switched from  $I_F = 10 \text{ mA}$ ;  $t_r = 20 \text{ ns}$ .

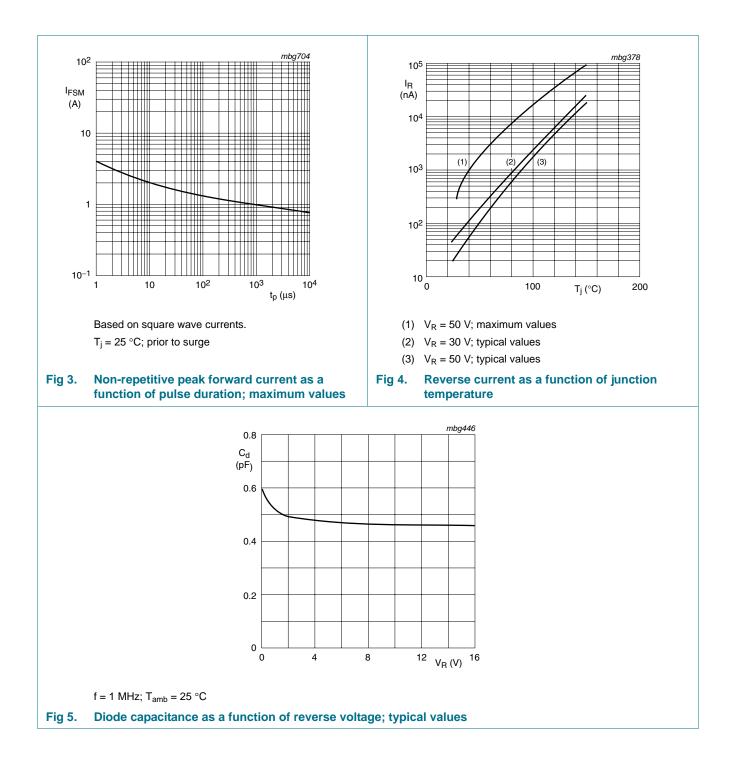


PMBD7000 Product data sheet

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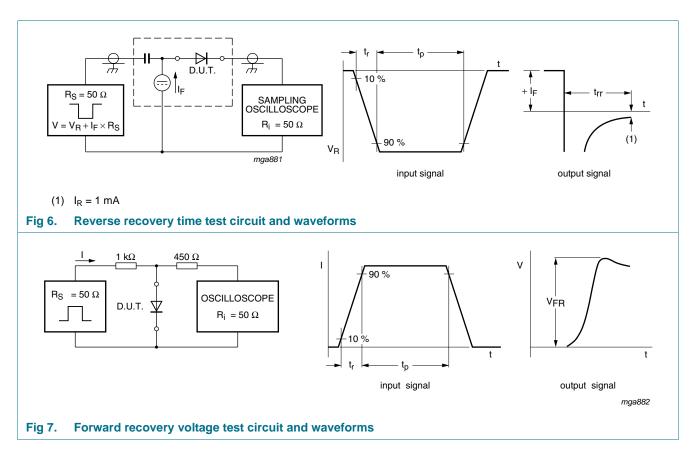
# **PMBD7000**

#### Double high-speed switching diode



#### Double high-speed switching diode

### 8. Test information

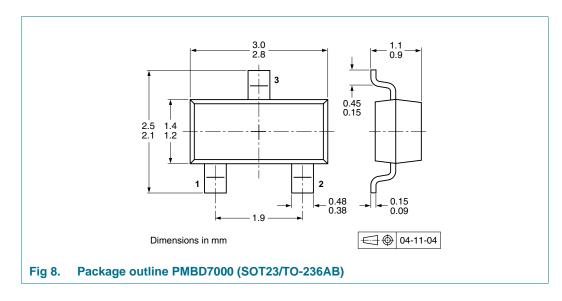


#### 8.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard *Q101* - *Stress test qualification for discrete semiconductors*, and is suitable for use in automotive applications.

Double high-speed switching diode

### 9. Package outline



# **10. Packing information**

#### Table 8. Packing methods

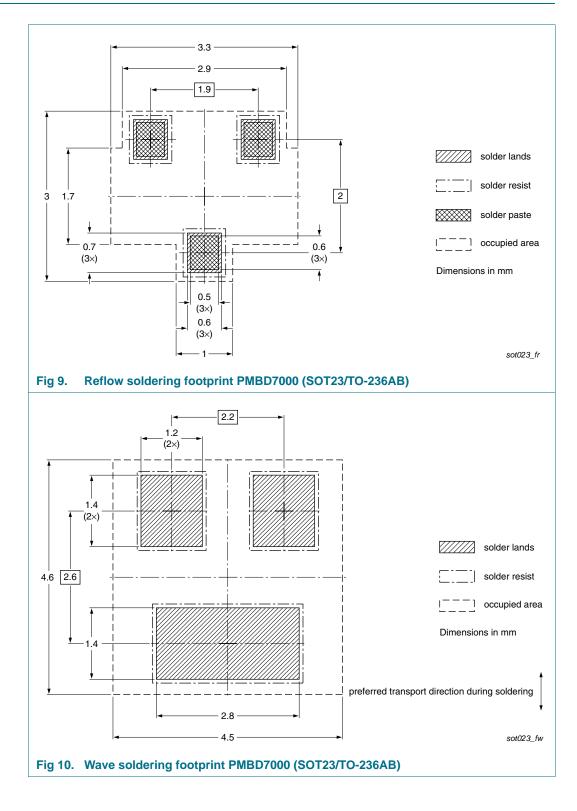
The indicated -xxx are the last three digits of the 12NC ordering code.[1]

Type number	Package	Description	Packing	quantity
			3000	10000
PMBD7000	SOT23	4 mm pitch, 8 mm tape and reel	-215	-235

[1] For further information and the availability of packing methods, see <u>Section 14</u>.

#### Double high-speed switching diode

### 11. Soldering



#### Double high-speed switching diode

# 12. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes		
PMBD7000 v.4	20100916	Product data sheet	-	PMBD7000_3		
Modifications:		of this data sheet has been of NXP Semiconductors.	redesigned to comply v	vith the new identity		
	<ul> <li>Legal texts</li> </ul>	have been adapted to the r	new company name whe	ere appropriate.		
	Table 4 "Ma	arking codes": updated				
	• <u>Table 7 "Characteristics"</u> : corrected $V_F$ unit for condition $I_F = 150 \text{ mA}$					
	• Figure 2: updated					
	<ul> <li>Section 8 "Test information": figure title of Figure 6 amended</li> </ul>					
	Section 8.1	<ul> <li>Section 8.1 "Quality information": added</li> </ul>				
	Section 13	"Legal information": update	d			
PMBD7000_3	19990511	Product specification	-	PMBD7000_2		
PMBD7000_2	19960918	Product specification	-	PMBD7000_1		
PMBD7000 1	19960419	Product specification	-	-		

### 13. Legal information

#### 13.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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Product data sheet

PMBD7000

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#### Double high-speed switching diode

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#### Double high-speed switching diode

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